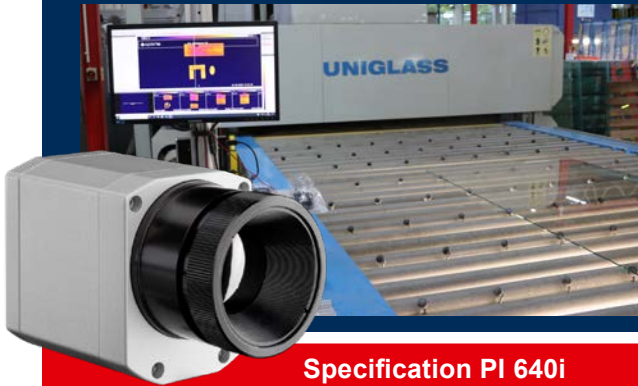


### Glass inspection system for process control in glass tempering machines



### Features

- Top down system with additional reference pyrometer from underneath for automatic emissivity correction on standard and Low-E glasses
- Digitally controlled lens protection system (DCLP) avoids extra air purging
- Glass area calculation
- Pre-assembled system for easy installation on glass tempering furnaces
- Automatic scan line adjustment – insensitive to distortions

#### Specification PI 640i

#### Specification reference sensor CT G5L

Optical resolution	640 x 480 pixels	Temperature range	100 °C ... 1200 °C
Detector	FPA, uncooled (17 µm x 17 µm)	Spectral range	5 µm
Spectral range	8 – 14 µm	Optical resolution (90 % energy)	10:1
Temperature ranges	-20 ... 100 °C, 0 ... 250 °C, (20) 150 ... 900 °C <sup>1)</sup>	System accuracy (at T <sub>Amb</sub> 23 ±5 °C)	±2 °C or ±1 % <sup>3)</sup>
Frame rate	32 Hz / 125 Hz @ 640 x 120 pixels	Repeatability (at T <sub>Amb</sub> 23 ±5 °C)	±0.5 °C or ±0.5 % <sup>3)</sup>
Optics (FOV)	60° x 45° FOV / f = 10.5 mm or 90° x 66° FOV / f = 7.7 mm	Temperature resolution (NETD)	0.1 K
Thermal sensitivity (NETD)	40 mK	Response time (90 % signal)	120 ms
Accuracy	±2 °C or ±2 %, whichever is greater	Emissivity/ Gain (adjustable via programming keys or software)	0.100 – 1.100
PC interface	USB 2.0 / optional USB GigE (PoE) interface	Environmental rating	IP 65 (NEMA-4)
Process interface (PIF), industrial	2x 0 – 10 V input, digital input (max. 24 V), 3x 0/4 – 20 mA output, 3x relay (0 – 30 V/ 400 mA), fail-safe relay	Ambient temperature	-20 °C ... 85 °C (sensing head) 0 °C ... 85 °C (electronics)
Ambient temperature	0 ... 50 °C	Storage temperature	-40 °C ... 85 °C (sensing head) -40 °C ... 85 °C (electronics)
Relative humidity	20 – 80 %, non-condensing	Vibration (sensor)	IEC 68-2-6: 3 G, 11 – 200 Hz, any axis
Enclosure (size / rating)	46 x 56 x 76 – 100 mm (depending on lens + focus position) / IP 67 (NEMA)	Shock (sensor)	IEC 68-2-27: 50 G, 11 ms, any axis
Weight	269 - 340 g (depending on lens)	Weight	42 g (sensing head) 420 g (electronics)
Shock / Vibration <sup>2)</sup>	IEC 60068-2-27 (25G and 50G), IEC 60068-2-6 (sinus shaped), IEC 60068-2-64 (broadband noise)		

#### Cable length

Electrical cabinet to PI imager (USB, PIF, Shutter)	10 m
Electrical cabinet to reference sensor (CT G5 head cable, Shutter)	10 m
Electrical cabinet to remote control box	10 m
Ethernet, Cat. 6	10 m

<sup>1)</sup> Accuracy effective starting at 150 °C

<sup>2)</sup> For more details see operator's manual

<sup>3)</sup> Whichever is greater

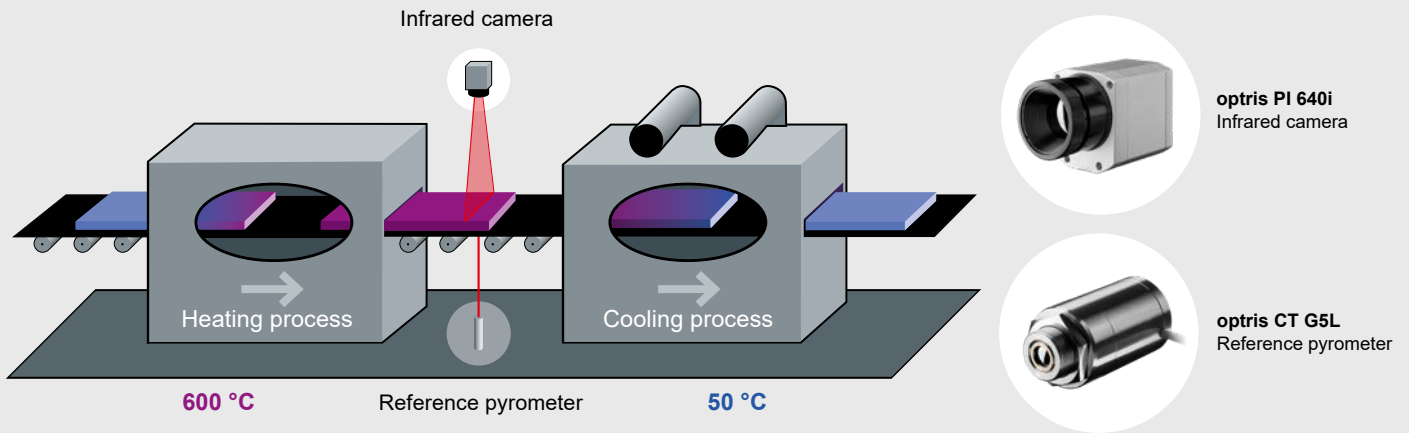
#### Scope of supply Top Down GIS 640 R

- PI 640i imager with 60° or 90° FOV
- Industrial Process Interface
- CT G5L reference sensor with USB interface and calibration certificate
- DCLP Shutter system with mounting brackets for imager and reference sensor
- USB Server Gigabit
- Control cabinet
- Cable set
- Remote control box
- Software package
- 100-230 V AC/ 24 V DC power supply for initial start-up

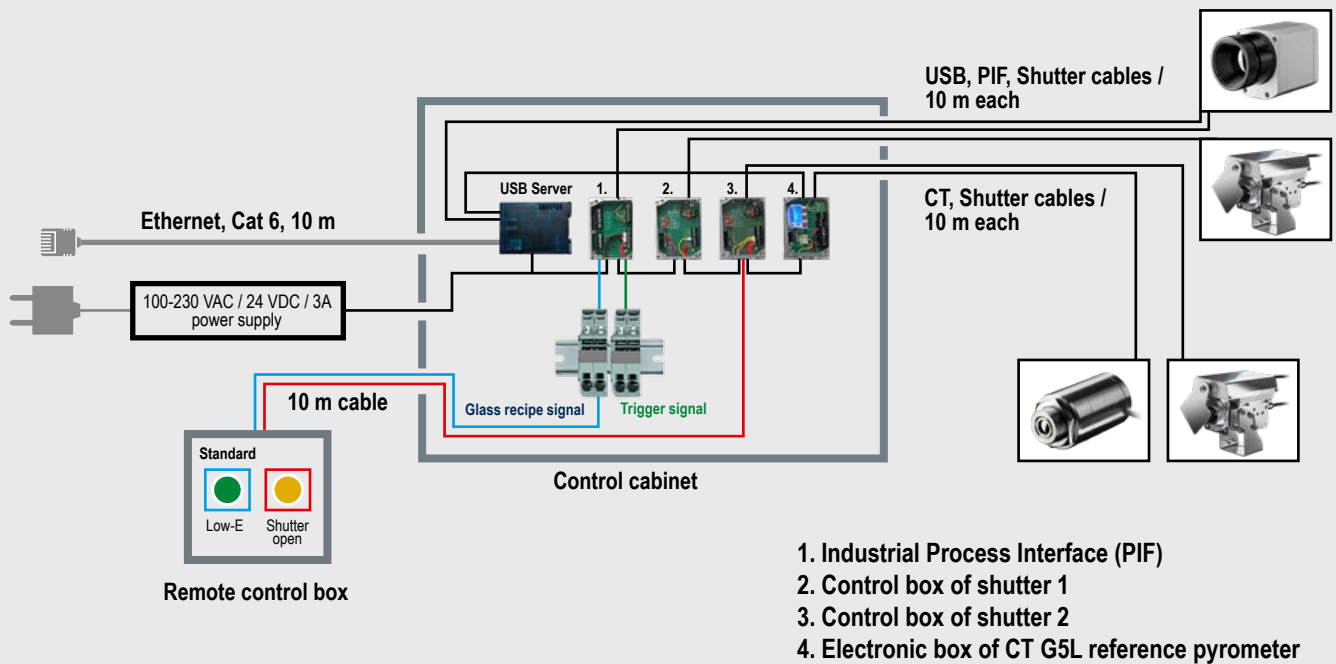
# optris Top Down GIS 640 R

## TECHNICAL DATA

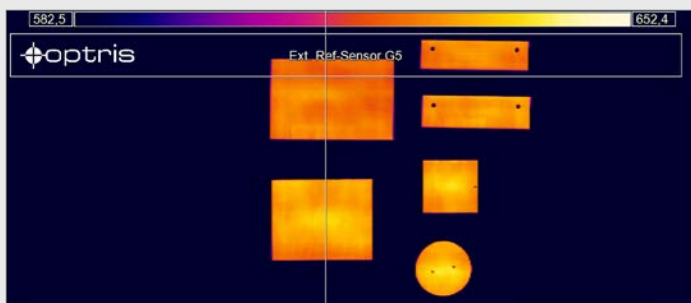
### Measurement principle



### System overview



### Thermal image



### Software PIX Connect

